

# D1FK60

Fast Recovery Diodes  
600V, 0.8A

## Feature

- Small SMD
- High Voltage
- Low Noise
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

## OUTLINE

Package (House Name): 1F  
Package (JEDEC Code): DO-214AC



## Equivalent circuit



## Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T <sub>stg</sub>		-55 to 150	°C
Junction temperature	T <sub>j</sub>		-55 to 150	°C
Repetitive peak reverse voltage	V <sub>RRM</sub>		600	V
Average forward current	I <sub>F(AV)</sub>	50Hz sine wave, Resistance load, Tl=124°C	0.8	A
Average forward current	I <sub>F(AV)</sub>	50Hz sine wave, Resistance load, On alumina substrate, Ta=29°C ※	0.8	A
Average forward current	I <sub>F(AV)</sub>	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=33°C ※	0.6	A
Surge forward current	I <sub>FSM</sub>	50Hz sine wave, Non-repetitive 1 cycle, Peak value, Tj=25°C	20	A

※ : See the original Specifications

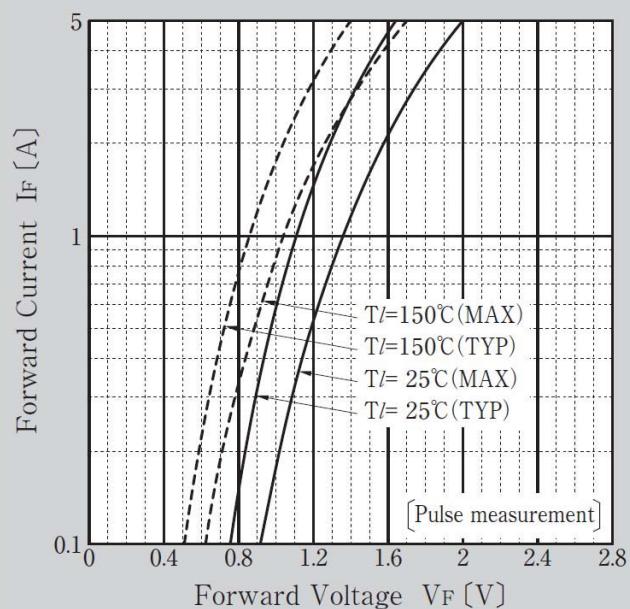
**Electrical Characteristics** (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	$V_F$	IF=0.8A, Pulse measurement			1.3	V
Reverse current	$I_R$	VR=600V, Pulse measurement			10	$\mu A$
Reverse recovery time	trr	IF=0.5A, IR=1.0A, 0.25IR			75	ns
Total capacitance	Ct	f=1MHz, VR=10V		11		pF
Thermal resistance	Rth(j-l)	Junction to lead			23	$^{\circ}C/W$
Thermal resistance	Rth(j-a)	Junction to ambient, On alumina substrate	※		108	$^{\circ}C/W$
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate	※		157	$^{\circ}C/W$

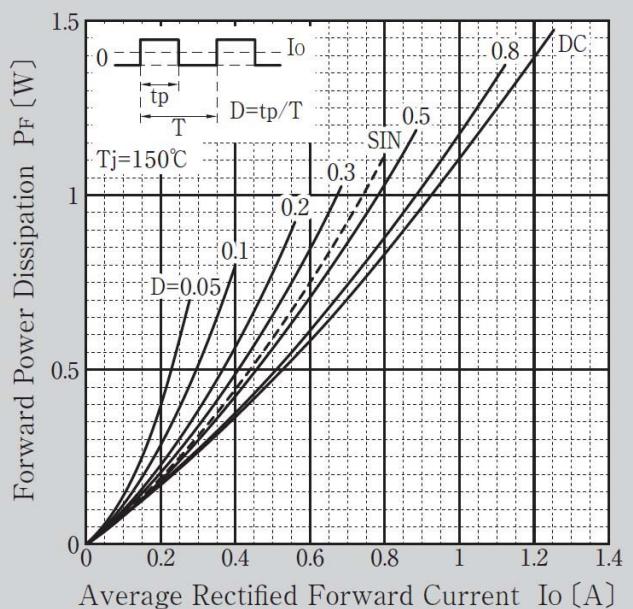
※ :See the original Specifications

## CHARACTERISTIC DIAGRAMS

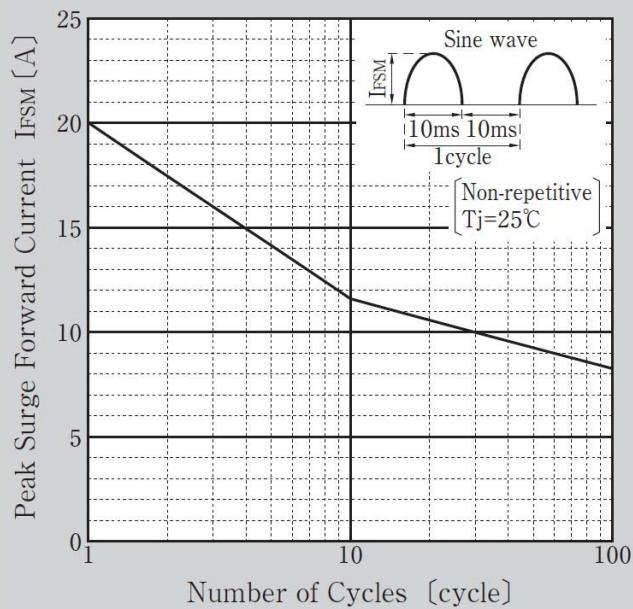
### Forward Voltage



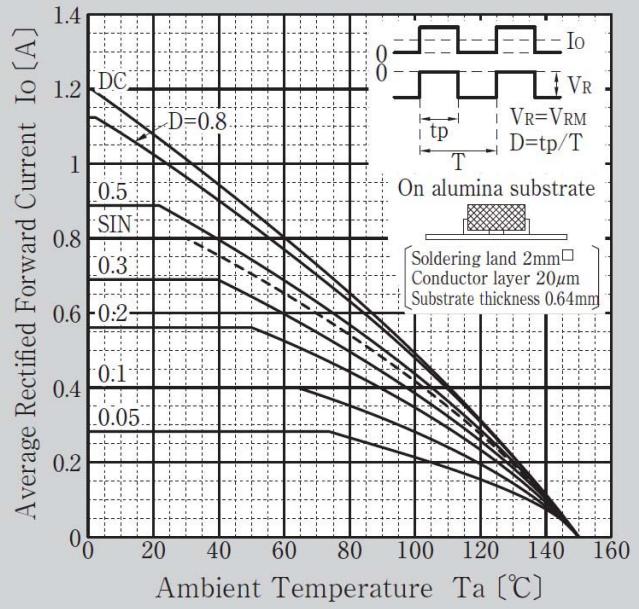
### Forward Power Dissipation



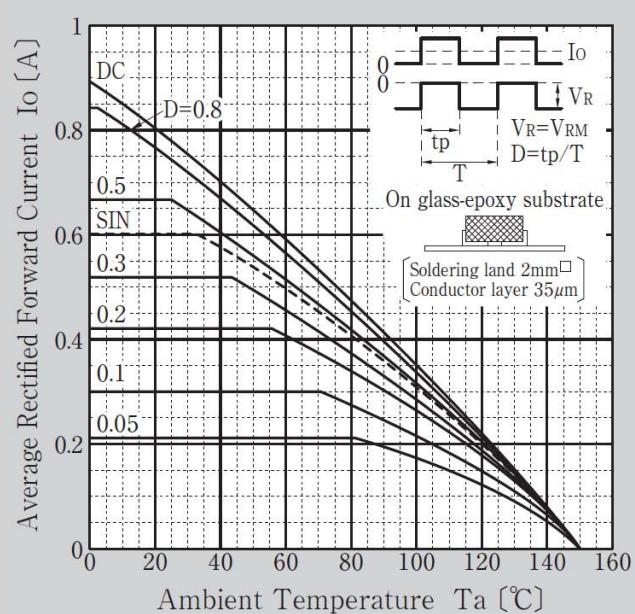
### Peak Surge Forward Current Capability



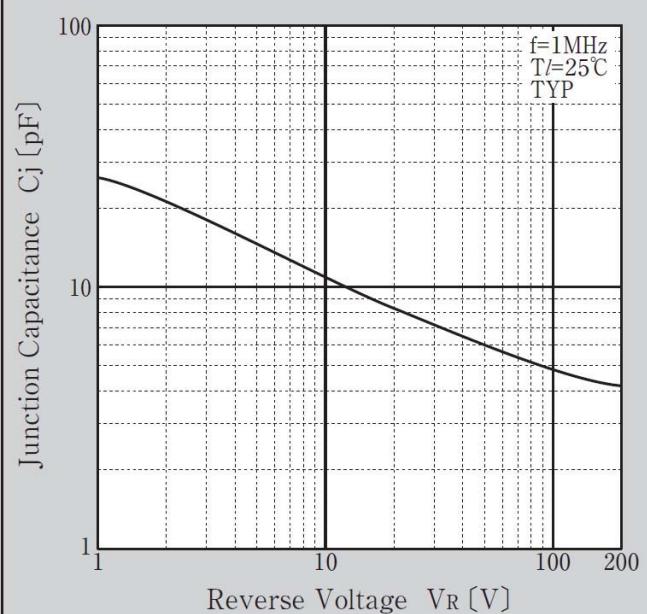
### Derating Curve



### Derating Curve



### Junction Capacitance



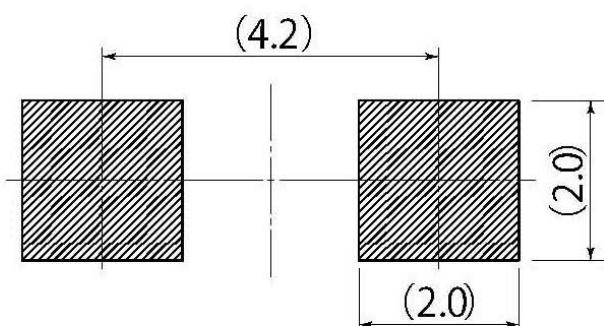
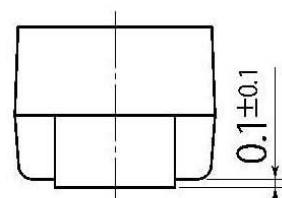
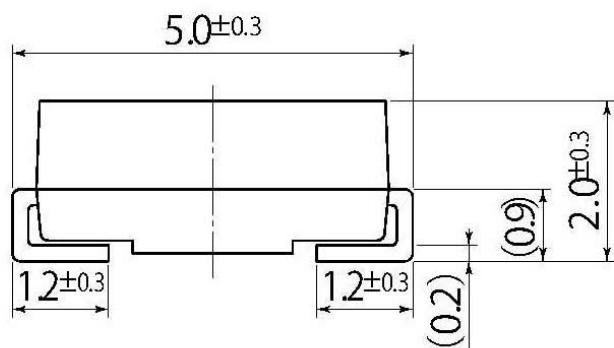
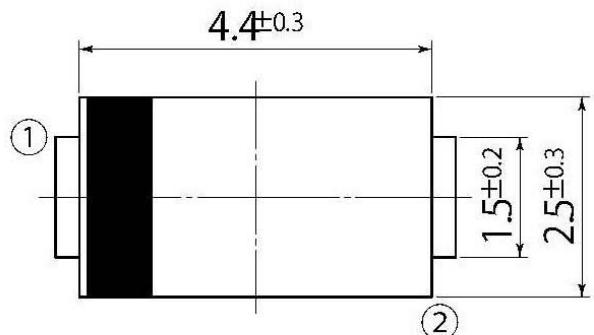
## Outline Dimensions

unit:mm

scale: 10/1

B3

JEDEC Code	DO-214AC
JEITA Code	—
House Name	1F, CF



Referential Soldering Pad

- Optimize soldering pad to the board design and soldering condition.

## Notes

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### 【Specific applications】

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